WNSC6D20650BT2-A

Silicon Carbide Diode

Rev.01 - 23 December 2022 Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO263-2L (D2PAK) plastic package, designed for high frequency switched-mode power supplies.

RoHS Halogen-Free

AEC - Q101 Qualified

2. Features and benefits

- New 6th Generation Technology
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Forward Surge Capability I_{FSM}
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- AEC-Q101 qualified

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives
- On board charger

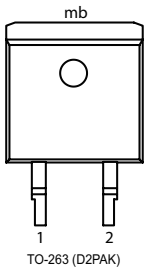
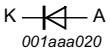
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage			650			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T_{mb} ≤ 133 °C; Fig. 1; Fig. 2; Fig. 3		20			A
T_j	junction temperature			175			°C
Symbol	**Parameter**	**Conditions**	**Notes**	**Min**	**Typ**	**Max**	**Unit**
Static characteristics							
V_F	forward voltage	I_F = 20 A; T_j = 25 °C; Fig. 5		-	1.26	1.40	V
		I_F = 20 A; T_j = 150 °C; Fig. 5		-	1.35	1.55	V
Dynamic characteristics							
Q_r	recovered charge	I_F = 20 A; dI_F/dt = 500 A/µs; V_R = 400 V; T_j = 25 °C; Fig. 7		-	48	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 TO-263 (D2PAK)	 *001aaa020*
2	A	anode		
mb	K	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC6D20650BT2-A	TO263-2L	WNSC6D20650BT2-A6J	Reel	800	TO263N-2L	14-Oct-2022

7. Marking

Table 4. Marking codes

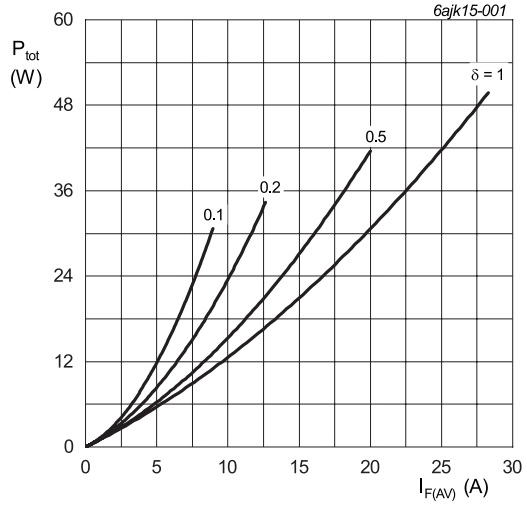
Type number	Marking codes
WNSC6D20650BT2-A	WNSC6D 20650BT2-A

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			650	V
V_{RWM}	crest working reverse voltage			650	V
V_R	reverse voltage	DC		650	V
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; $T_{mb} \leq 133$ °C; Fig. 1; Fig. 2; Fig. 3		20	A
I_{FRM}	repetitive peak forward current	δ = 0.5; t_p = 25 µs; $T_{mb} \leq 133$ °C; square-wave pulse		40	A
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		140	A
		t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		1000	A
I^2t	I^2t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms		98	A^2s
T_{stg}	storage temperature			-55 to 175	°C
T_j	junction temperature			-55 to 175	°C



$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$
V_o = 0.984 V; R_s = 0.0274 Ω

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

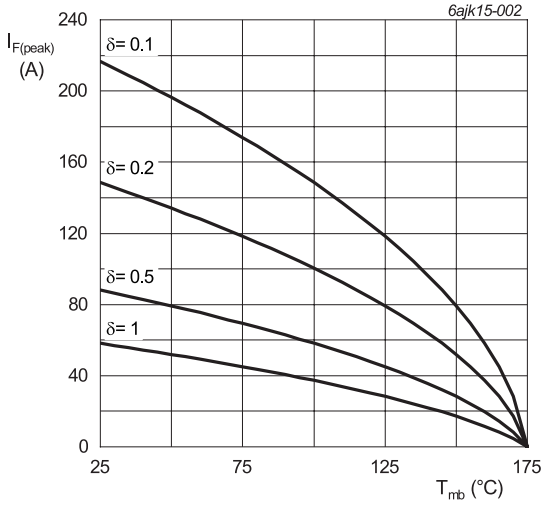


Fig. 2. Current derating as a function of mounting base temperature

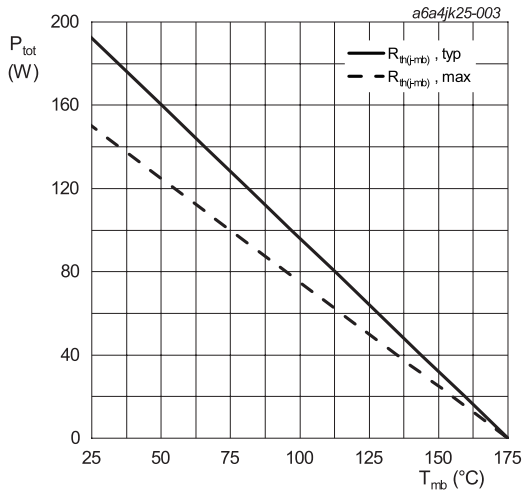


Fig. 3. Total power dissipation as a function of mounting base temperature

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 4		-	0.78	1	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

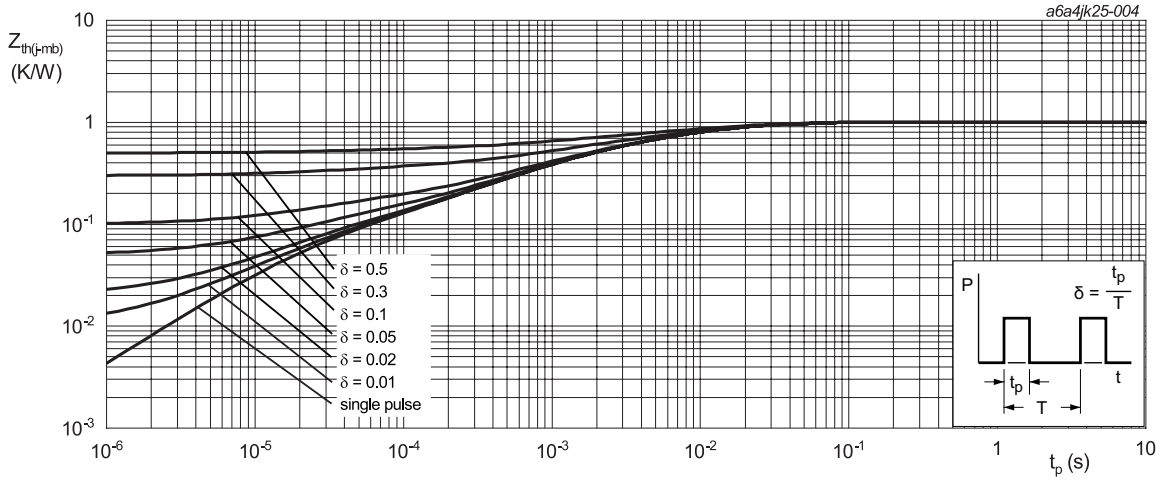
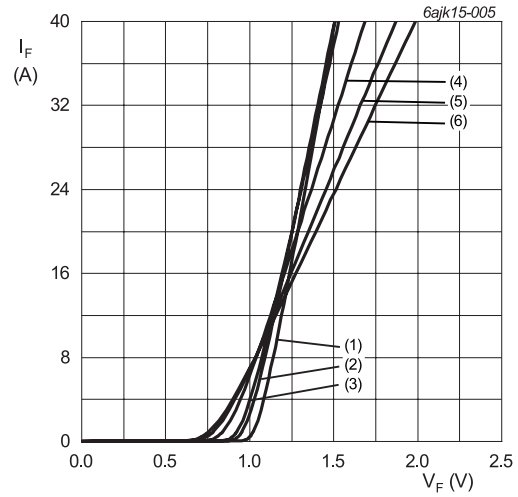


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V_F	forward current	I_F = 20 A; T_j = 25 °C; Fig. 5		-	1.26	1.40	V
		I_F = 20 A; T_j = 150 °C; Fig. 5		-	1.35	1.55	V
		I_F = 20 A; T_j = 175 °C; Fig. 5		-	1.40	1.60	V
I_R	reverse current	V_R = 650 V; T_j = 25 °C; Fig. 6		-	2	100	µA
		V_R = 650 V; T_j = 175 °C; Fig. 6		-	30	400	µA
Dynamic characteristics							
Q_r	recovered charge	I_F = 20 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 25 °C; Fig. 7		-	48	-	nC
C_d	diode capacitance	f = 1 MHz; V_R = 1 V; T_j = 25 °C		-	1005	-	pF
		f = 1 MHz; V_R = 300 V; T_j = 25 °C		-	110	-	pF
		f = 1 MHz; V_R = 600 V; T_j = 25 °C		-	102	-	pF
E_{as}	non-repetitive avalanche energy	I_R = 7.8 A; L = 5 mH; $T_{j(init)}$ = 25 °C		150	-	-	mJ



V_o = 0.984 V; R_s = 0.0274 Ω
(1) T_j = -55 °C; typical values
(2) T_j = 0 °C; typical values
(3) T_j = 25 °C; typical values
(4) T_j = 100 °C; typical values
(5) T_j = 150 °C; typical values
(6) T_j = 175 °C; typical values

Fig. 5. Forward current as a function of forward voltage; typical values

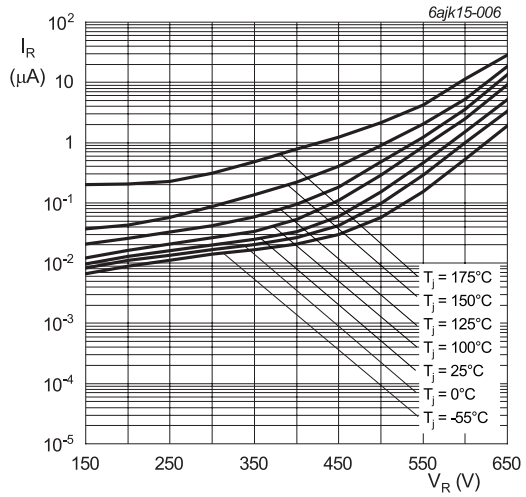


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

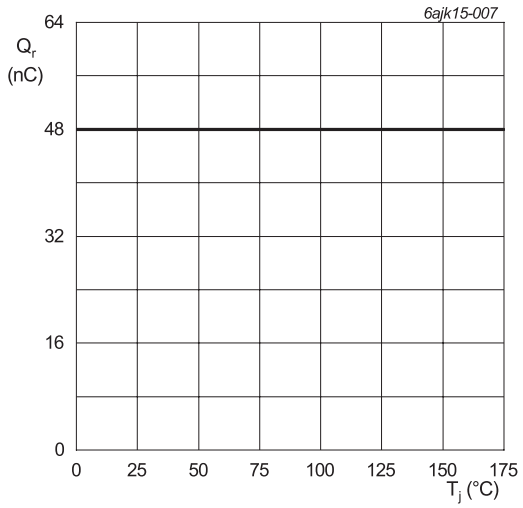
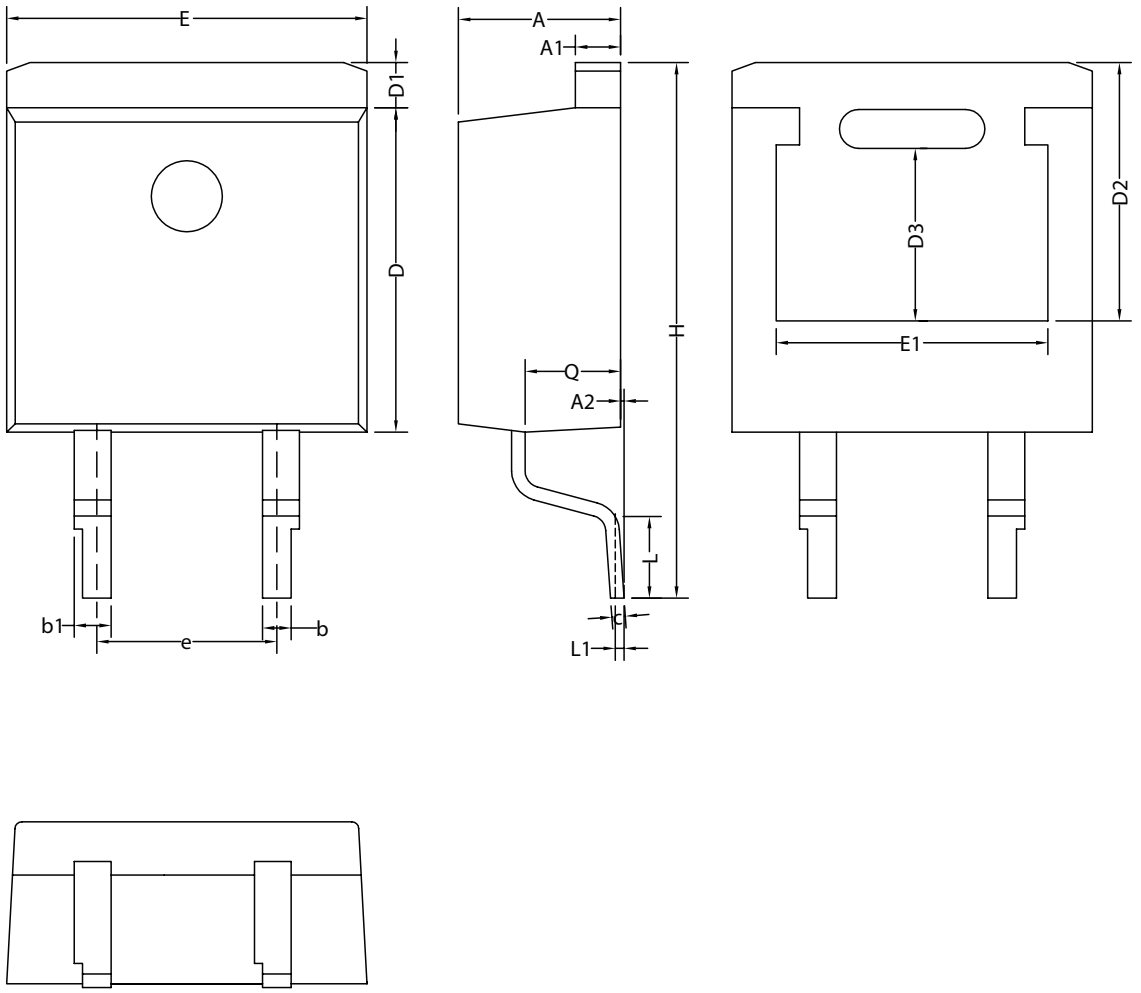


Fig. 7. Recovered charge as a function of junction temperature

11. Package outline

Plastic single-ended surface-mounted package (D2PAK); 2 leads TO263-2L



Note:
All dimensions do not include mold flash or protrusion.

Unit		A	A1	A2	b	b1	c	D	D1	D2	D3	e	E	E1	H	L	L1	Q
MM	min	4.40	1.22	0.00	0.77	1.00	0.34	9.05	1.17	7.13	4.71	5.08 (BSC)	10.06	7.51	14.70	2.00	0.25 (BSC.)	2.59
	max	4.70	1.40	0.25	0.90	1.45	0.47	9.25	1.40	7.43	5.01		10.26	7.81	15.50	2.60		2.79

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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13. Contents

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Date of release: 23 December 2022